

Antitarnish AG 110

Antitarnish AG 110 is a post-treatment process for electro-deposited silver surfaces, preventing the tarnishing of the silver layers caused by development of a sulphur film. Antitarnish AG 110 does not affect the solderability of the silver layers.

After plating the parts must be thoroughly rinsed prior to immersing into Antitarnish AG 110. An intermediate drying of the layers isn't necessary. A temperature resistance for Antitarnish AG 110 up to 200 °C is guaranteed.

Antitarnish AG 110 does not contain Cr(VI).

The information in this data sheet is based on laboratory as well as practical experience. Figures quoted for operating limits and replenishment quantities are for guidance. Actual values necessary will depend on the components being plated (material and geometry), their application and plating plant conditions.

Important:

Please read this instruction carefully prior to the use of the process and carefully follow all the parameters that have a direct influence on the operation. We reserve the right to make technical changes. In the interest of safety, please pay attention to the hazard warnings on the labels of the containers. The minimum shelf life of the products is included on the labels and is also available in the appropriate Quality Assurance (QA03).

The current IMDS number of the layer deposited from the process is available on the internet at www.schloetter.com/downloads.

For the storage of chemical products the TRGS 510 must be followed.

If the additives used in this process contain a SVHC-substance, then this will be specified in the corresponding Material Safety Data Sheet, section 15.

